PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7547487

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DOW SILICONES CORPORATION	08/27/2019

RECEIVING PARTY DATA

Name:	DDP SPECIALTY ELECTRONIC MATERIALS US 9, LLC
Street Address:	974 CENTER ROAD
City:	WILMINGTON
State/Country:	DELAWARE
Postal Code:	19805

PROPERTY NUMBERS Total: 3

Property Type	Number
Application Number:	16755043
Application Number:	16755048
Application Number:	16755049

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name:	STERNE, KESSLER, GOLDSTEIN & FOX P.L.L.C.
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Address Line 4:	WASHINGTON, D.C. 20005

ATTORNEY DOCKET NUMBER:	5096.001-2,002-2,003-2
NAME OF SUBMITTER:	MATTHEW S. BODENSTEIN
SIGNATURE:	/Matthew S. Bodenstein/
DATE SIGNED:	09/20/2022

Total Attachments: 27

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FORM OF
PATENT ASSIGNMENT

This PATENT ASSIGNMENT (this "Assignment"), dated as of November 1, 2018 (the "Effective Date"), is by and between Dow Silicones Corporation (f/k/a Dow Corning Corporation), a Michigan corporation ("Assignor") and DDP Specialty Electronic Materials US 9, LLC, a Delaware limited liability company ("Assignee"), (each a "Party" and collectively, the "Parties").

WHEREAS, Assignor owns the issued patents and patent applications set forth on Schedule A hereto (the foregoing, including all patents issuing from any patent applications, collectively, the "Assigned Patents"); and

WHEREAS, the Parties hereto agree that the Assignor contribute, transfer, assign and convey to the Assignee all of its right, title and interest in and to the Assigned Patents and that the Assignee accept such contribution, transfer, assignment and conveyance of such Assigned Patents;

NOW, THEREFORE, in consideration of the foregoing and the covenants and agreements contained in this Assignment, the receipt and sufficiency of which are hereby acknowledged, the Parties hereby agree as follows:

1. Conveyance. Assignor hereby assigns, transfers and conveys to Assignee all of Assignor's right, title and interest in and to the Assigned Patents, together with any and all (a) related continuations, continuations-in-part, divisionals, reissues, reexaminations, substitutions, extensions, and foreign equivalents thereof and (b) priority rights derived from any the Assigned Patents, or the items described in the foregoing subsection (a), by virtue of the International Convention for the Protection of Industrial Property and any other rights provided under applicable treaties or conventions, including rights in any and all provisional applications, together with all rights and remedies against past, present, and future infringement, misappropriation, or other violation thereof, including the right to enforce the foregoing and to sue for and recover profits and damages for any and all infringements, misappropriations or violations thereof, whether past, present or future, to the full end of the term or terms for which said patents may be granted, as fully and entirely as the same would have been held and enjoyed by Assignor without this assignment (the rights transferred under this Section 1 cumulatively, the "Assigned Rights").

2. Recordation; Further Assurances. Assignor and Assignee shall each take any and all additional actions as may be reasonably necessary to effect the transactions contemplated hereby, including Assignor's execution of individual assignment documentation prepared by Assignee at Assignee's expense for filing with the authorities of each individual country. In furtherance of the foregoing, Assignor agrees that with respect to the Assigned Patents it will enter into an assignment agreement suitable for filing with the authorities of each individual country (each an "Recordal Instrument"). The Parties agree that any Recordal Instrument shall give no greater rights or remedies in respect of the transaction completed in such Recordal

Instrument than those provided for herein and Section 4 of this Assignment shall apply to any Recordal Instrument as if fully set forth therein. As between the Parties, the responsibility to file assignments with the national patent offices of each country for the Assigned Patents shall be on the Assignee and the Assignee shall bear the cost of filing such assignments (unless, as of the Effective Date, the patent registration or application is not properly recorded in the name of the Assignor or an Affiliate of Assignor, in which case, at the request of Assignee, the Parties shall reasonably cooperate to make the necessary corrective filings and recordals of the documents that are available to them and shall split evenly any expenses in connection with the foregoing corrections and each Party shall provide any receipts and expense documentation to the other Party for the purposes of splitting such expenses).

3. Prosecution and Maintenance. For the avoidance of doubt but without limiting the obligations set forth in Section 2 hereof, as of and following the Effective Date, Assignor will have no responsibility to take any action to maintain any of the patents included in the Assigned Rights or further prosecute or seek issuance of any patent applications included in the Assigned Rights, including payment of fees, responses to any office action or other inquiries from agents of governmental entities or registrars, or otherwise.

4. No Claims. Except with respect to Section 2 of this Assignment, neither Party nor any of their respective affiliates or representatives will have, or be subject to, any liability or indemnification obligation under this Assignment to the other Party, any of its affiliates or representatives or any other entity or person resulting from, or in connection with, this Assignment or the transactions contemplated hereby. Except with respect to Section 2, each of the Parties hereby agrees (a) not to bring any claim or Action (as defined herein) under this Assignment against the other Party, its affiliates or representatives and (b) to cause its respective affiliates and representatives to comply with this Section 4. "Action" shall mean any claims, actions, suits, inquiries, proceedings or investigations by or before any governmental authority or arbitral tribunal.

5. Disclaimer of Representations and Warranties. ASSIGNEE (ON BEHALF OF ITSELF AND ITS AFFILIATES) UNDERSTANDS AND AGREES THAT NO PARTY TO THIS ASSIGNMENT IS REPRESENTING OR WARRANTING IN ANY WAY IN THIS ASSIGNMENT, AND HEREBY EXPRESSLY DISCLAIMS ALL REPRESENTATIONS AND WARRANTIES, AS TO THE ASSIGNED PATENTS AND THE OTHER ASSIGNED RIGHTS, AS TO ANY CONSENTS OR APPROVALS (INCLUDING APPROVALS FROM ANY GOVERNMENTAL ENTITIES) REQUIRED IN CONNECTION HEREWITH OR THEREWITH, AS TO THE VALUE OR FREEDOM FROM ANY SECURITY INTERESTS OF OR THE NON-INFRINGEMENT OR ABSENCE OF OTHER VIOLATION, VALIDITY OR ENFORCEABILITY OR ANY OTHER MATTER CONCERNING THE ASSIGNED PATENTS AND OTHER PATENTS AND PATENT APPLICATIONS INCLUDED IN THE ASSIGNED RIGHTS, AND ALL OF THE ASSIGNED PATENTS AND OTHER ASSIGNED RIGHTS ARE BEING TRANSFERRED ON AN "AS IS, WHERE IS" AND "WITH ALL FAULTS" BASIS.

6. Successors and Assigns. The provisions of this Assignment and the obligations and rights hereunder shall be binding upon, inure to the benefit of and be enforceable by (and against) the Parties and their respective successors and permitted transferees and assigns.

7. Counterparts. This Assignment may be executed in more than one counterpart, all of which shall be considered one and the same agreement, and shall become effective when one or more such counterparts have been signed by each of the Parties and delivered to each of the Parties.

8. Title and Headings. Titles and headings to sections herein are inserted for the convenience of reference only and are not intended to be a part of or to affect the meaning or interpretation of this Assignment.

9. Governing Law. This Assignment and any dispute arising out of, in connection with or relating to this Assignment shall be governed by and construed in accordance with the Laws of the State of Delaware, without giving effect to the conflicts of laws principles thereof.

[Signature Page Follows]

IN WITNESS WHEREOF, Assignor and Assignee have duly executed this Assignment as of the date first written above.

ASSIGNOR:

DOW SILICONES CORPORATION

By: ____________________
Name: Jonathan P. Wendt
Title: Secretary

THE STATE OF MICHIGAN

County of Midland

This instrument was executed before me on this 23rd day of August, 2019, by Jonathan P. Wendt, the Secretary of Dow Silicones Corporation, a Michigan corporation, on behalf of said company.

____
Notary Public in and for
The State of Michigan

KIMBERLY S. BIRCH
NOTARY PUBLIC - STATE OF MICHIGAN
COUNTY OF MIDLAND
My Commission Expires March 16, 2025
Acting in the County of MIDLAND

Signature Page to Patent Assignment

Acknowledged and Accepted:

ASSIGNEE:

DDP SPECIALTY ELECTRONIC
MATERIALS US 9, LLC

By:____________________
Name: Calissa W. Brown
Title: Assistant Secretary

THE STATE OF DELAWARE

County of New Castle

This instrument was executed before me on this 27th day of August, 2019, by Calissa W. Brown, the Assistant Secretary (title) of DDP Specialty Electronic Materials US 9, LLC, a Delaware limited liability company, on behalf of said company.

Mary Jane Ford
Notary Public in and for
The State of DELAWARE

MARY-JANE FORD
Printed or Typed Name of Notary

My commission expires JAN. 4, 2023

MARY-JANE FORD
EXPIRES JAN. 4, 2023

SCHEDULE A TO PATENT ASSIGNMENT

SCHEDULE A
PATENTS

CASE REFERENCE	COUNTRY	TITLE	OWNER	FILING_DATE	APP._NUMBER	PUB._NUMBER	GRANT_DATE	GRANT_NUMBE
79673-TW-NP	Taiwan	THIO(DI)SILANES	DOW SILICONES CORPORATION	10/11/2017	106134800	201813972		
79673-TW-NP[2]	Taiwan	THIO(DI)SILANES	DOW SILICONES CORPORATION	10/12/2017	106134970	201813971		
79673-WO-PCT	International Procedure	THIO(DI)SILANES	DOW SILICONES CORPORATION	10/10/2017	PCT/US17/055857	WO/2018/071371		
79673-WO-PCT[2]	International Procedure	THIO(DI)SILANES	DOW SILICONES CORPORATION	10/10/2017	PCT/US17/055874	WO/2018/071379		
79679-CN-PCT	China	HIGH PURITY TRISILYLAMINE, METHODS OF MAKING, AND USE	DOW SILICONES CORPORATION	12/16/2016	PCT/US16/067143			
79679-EP-EPT	European Procedure (Patents)	HIGH PURITY TRISILYLAMINE, METHODS OF MAKING, AND USE	DOW SILICONES CORPORATION	12/16/2016	16840347.5			
79679-JP-PCT	Japan	HIGH PURITY TRISILYLAMINE, METHODS OF MAKING, AND USE	DOW SILICONES CORPORATION	12/16/2016	2018-531566			
79679-KR-PCT	SOUTH KOREA	HIGH PURITY TRISILYLAMINE, METHODS OF MAKING, AND USE	DOW SILICONES CORPORATION	12/16/2016	10-2018-7019383			
79679-TW-NP	Taiwan	HIGH PURITY TRISILYLAMINE, METHODS OF MAKING, AND USE	DOW SILICONES CORPORATION	12/16/2016	105141895	201722849		
79679-US-PCT	United States Of America	HIGH PURITY TRISILYLAMINE, METHODS OF MAKING, AND USE	DOW SILICONES CORPORATION	12/16/2016	16/061477			
79848-TW-NP	Taiwan	TRANSSILYLATION CATALYSIS	DOW SILICONES CORPORATION	12/01/2017	106142099	201823149		
79848-WO-PCT	International Procedure	TRANSSILYLATION CATALYSIS	DOW SILICONES CORPORATION	11/29/2017	PCT/US17/063588	WO/2018/125476		
79930-CN-PCT	China	METHOD FOR MAKING AN ORGANOAMINOSILANE; A METHOD FOR MAKING A SILYLAMINE FROM THE ORGANOAMINOSILANE	DOW SILICONES CORPORATION	12/16/2016	PCT/US16/067152			
79930-EP-EPT	European Procedure (Patents)	METHOD FOR MAKING AN ORGANOAMINOSILANE; A METHOD FOR MAKING A SILYLAMINE FROM THE ORGANOAMINOSILANE	DOW SILICONES CORPORATION	12/16/2016	16840348.3			
79930-JP-PCT	Japan	METHOD FOR MAKING AN ORGANOAMINOSILANE; A METHOD FOR MAKING A SILYLAMINE FROM THE ORGANOAMINOSILANE	DOW SILICONES CORPORATION	12/16/2016	2018-531616			
79930-KR-PCT	SOUTH KOREA	METHOD FOR MAKING AN ORGANOAMINOSILANE; A METHOD FOR MAKING A SILYLAMINE FROM THE ORGANOAMINOSILANE	DOW SILICONES CORPORATION	12/16/2016	10-2018-7019018			

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79930-TW-NP	Taiwan	METHOD FOR MAKING AN ORGANOAMINOSILANE; A METHOD FOR MAKING A SILYLAMINE FROM THE ORGANOAMINOSILANE	DOW SILICONES CORPORATION	12/16/2016	105141899	201734024

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79930-US-PCT	United States Of America	METHOD FOR MAKING AN ORGANOAMINOSILANE; A METHOD FOR MAKING A SILYLAMINE FROM THE ORGANOAMINOSILANE	DOW SILICONES CORPORATION	12/16/2016	16/061461			
80066-CN-PCT	China	TRIS(DISILANYL)AMINE	DOW SILICONES CORPORATION	12/16/2016	PCT/US16/067075			
80066-EP-EPT	European Procedure (Patents)	TRIS(DISILANYL)AMINE	DOW SILICONES CORPORATION	12/16/2016	16822354.3			
80066-JP-PCT	Japan	TRIS(DISILANYL)AMINE	DOW SILICONES CORPORATION	12/16/2016	2018-528601			
80066-KR-PCT	SOUTH KOREA	TRIS(DISILANYL)AMINE	DOW SILICONES CORPORATION	12/16/2016	10-2018-7018305			
80066-US-PCT	United States Of America	TRIS(DISILANYL)AMINE	DOW SILICONES CORPORATION	12/16/2016	15/776851			
80066-WO-PCT	International Procedure	TRIS(DISILANYL)AMINE	DOW SILICONES CORPORATION	12/16/2016	PCT/US16/067075	WO/2017/106587		
80067-TW-NP	Taiwan	CATALYSIS OF DEHYDROCOUPLING REACTIONS BETWEEN AMINES AND SILANES	DOW SILICONES CORPORATION	12/18/2017	106144433	201823255		
80067-WO-PCT	International Procedure	CATALYSIS OF DEHYDROCOUPLING REACTIONS BETWEEN AMINES AND SILANES	DOW SILICONES CORPORATION	11/29/2017	PCT/US17/063590	WO/2018/125477		
80234-CN-NP	China	METHOD FOR FABRICATING SEMICONDUCTOR DEVICE	DOW SILICONES CORPORATION	01/24/2018	201810069059.4			
80234-JP-NP	Japan	METHOD FOR FABRICATING SEMICONDUCTOR DEVICE	DOW SILICONES CORPORATION	01/24/2018	2018-9515			
80234-KR-NP	SOUTH KOREA	METHOD FOR FABRICATING SEMICONDUCTOR DEVICE	DOW SILICONES CORPORATION	02/09/2017	10-2017-0017908			
80234-TW-NP	Taiwan	METHOD FOR FABRICATING SEMICONDUCTOR DEVICE	DOW SILICONES CORPORATION	12/27/2017	106146025			
80234-US-NP	United States Of America	METHOD FOR FABRICATING SEMICONDUCTOR DEVICE	DOW SILICONES CORPORATION	01/25/2017	15/414913		08/14/2018	10049882
80416-TW-NP	Taiwan	METHOD OF MAKING A HALOSILOXANE	DOW SILICONES CORPORATION	05/31/2018	107118812			
80416-WO-PCT	International Procedure	METHOD OF MAKING A HALOSILOXANE	DOW SILICONES CORPORATION	05/24/2018	PCT/US18/034344			
80769-TW-NP	Taiwan	METHOD OF MAKING HALOSILOXANE	DOW SILICONES CORPORATION	06/01/2018	107119060			
80769-WO-PCT	International Procedure	METHOD OF MAKING HALOSILOXANE	DOW SILICONES CORPORATION	05/24/2018	PCT/US18/034402			
80813-EP-EPA	European Procedure (Patents)	A METHOD OF CLEANSING SKIN USING A TWO-PART, HYDROSILYLATION CURABLE SILICONE COMPOSITION	DOW SILICONES CORPORATION	03/28/2018	18305348.7			
80860-WO-PCT	International Procedure	METHOD FOR PRODUCING LED BY ONE STEP FILM LAMINATION	DOW SILICONES CORPORATION	05/18/2018	PCT/CN18/087460			
80870-TW-NP	Taiwan	SILICONE COMPOSITIONS AND ARTICLES FOR CONTROLLING LIGHT	DOW SILICONES CORPORATION	07/10/2018	107123796			
		SILICONE COMPOSITIONS AND						

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80870-WO-PCT	International Procedure	ARTICLES FOR CONTROLLING LIGHT	DOW SILICONES CORPORATION	07/13/2018	PCT/US18/041960

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80872-TW-NP	Taiwan	CURED SILICONE COMPOSITION FOR LED ENCAPSULANTS	DOW SILICONES CORPORATION			
80886-US-PSP[2]	United States Of America	ANTIFRICTION COATING (AFC) COMPOSITION AND AFC FORMED THEREFROM	DOW SILICONES CORPORATION	07/06/2018	62/694496	
80891-TW-NP	Taiwan	METHOD OF PREPARING PENTACHLORODISILANE AND PURIFIED REACTION PRODUCT COMPRISING SAME	DOW SILICONES CORPORATION	07/04/2018	107123211	
80891-WO-PCT	International Procedure	METHOD OF PREPARING PENTACHLORODISILANE AND PURIFIED REACTION PRODUCT COMPRISING SAME	DOW SILICONES CORPORATION	07/30/2018	PCT/US18/44390	
80892-TW-NP	Taiwan	1,1,1-TRIS(DIMETHYLAMINO)DISILANE AND METHOD OF PREPARING SAME	DOW SILICONES CORPORATION	07/04/2018	107123212	
80892-WO-PCT	International Procedure	1,1,1-TRIS(DIMETHYLAMINO)DISILANE AND METHOD OF PREPARING SAME	DOW SILICONES CORPORATION	07/30/2018	PCT/US18/44392	
80901-TW-NP	Taiwan	SYNTHESIS 1,1,1-TRICHLORODISILANE	DOW SILICONES CORPORATION	06/27/2018	107122060	
80901-WO-PCT	International Procedure	SYNTHESIS 1,1,1-TRICHLORODISILANE	DOW SILICONES CORPORATION	06/21/2018	PCT/US18/038711	
80972-TW-NP	Taiwan	METHOD OF MAKING A MIXTURE OF FAR BOILING SILANE AND SILOXANE	DOW SILICONES CORPORATION	07/25/2018	107125633	
80972-WO-PCT	International Procedure	METHOD OF MAKING A MIXTURE OF FAR BOILING SILANE AND SILOXANE	DOW SILICONES CORPORATION	06/22/2018	PCT/US18/039010	
81138-US-PSP	United States Of America	LUBRICATING GREASE COMPOSITION	DOW SILICONES CORPORATION	12/21/2017	62/608595	
81485-WO-PCT	International Procedure	CONTROL OF ADHESIVE DOMAINS	DOW SILICONES CORPORATION	07/19/2017	PCT/EP17/068212	WO 2018/015424
81496-TW-NP	Taiwan	HYDROSILYLATION-CURABLE SILICONE COMPOSITION	DOW SILICONES CORPORATION			
81496-US-PSP	United States Of America	HYDROSILYLATION-CURABLE SILICONE COMPOSITION	DOW SILICONES CORPORATION	11/16/2017	62/587235	
81496-WO-PCT	International Procedure	HYDROSILYLATION-CURABLE SILICONE COMPOSITION	DOW SILICONES CORPORATION			
81556-US-PSP	United States Of America	HYDROCARBYLOXY DISILANES	DOW SILICONES CORPORATION	12/08/2017	62/596202	
81682-US-PSP	United States Of America	LUBRICANT COMPOSITIONS	DOW SILICONES CORPORATION	07/18/2018	62/699777	
81710-EP-EPA	European Procedure (Patents)	TRANSDERMAL THERAPEUTIC SYSTEM FOR THE TRANSDERMAL ADMINISTRATION OF GUANFACINE COMPRISING AT LEAST ONE ADDITIVE	DOW SILICONES CORPORATION	12/05/2017	17205546.9	

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81710-US-PSP	United States Of America	TRANSDERMAL THERAPEUTIC SYSTEM FOR THE TRANSDERMAL ADMINISTRATION OF GUANFACINE COMPRISING AT LEAST ONE ADDITIVE	DOW SILICONES CORPORATION	10/11/2017	62/570745			
81711-EP-EPA	European Procedure (Patents)	TRANSDERMAL THERAPEUTIC SYSTEM FOR THE TRANSDERMAL ADMINISTRATION OF GUANFACINE COMPRISING A SILICONE POLYMER	DOW SILICONES CORPORATION	12/05/2017	17205543.6			
81711-US-PSP	United States Of America	TRANSDERMAL THERAPEUTIC SYSTEM FOR THE TRANSDERMAL ADMINISTRATION OF GUANFACINE COMPRISING A SILICONE POLYMER	DOW SILICONES CORPORATION	10/11/2017	62/570746			
81712-EP-EPA	European Procedure (Patents)	TRANSDERMAL THERAPEUTIC SYSTEM FOR THE TRANSDERMAL ASMINISTRATION OF GUANFACINE COMPRISING A SILICONE ACRYLIC HYBRI POLYMER	DOW SILICONES CORPORATION	12/05/2017	17205538.6			
81712-US-PSP	United States Of America	TRANSDERMAL THERAPEUTIC SYSTEM FOR THE TRANSDERMAL ASMINISTRATION OF GUANFACINE COMPRISING A SILICONE ACRYLIC HYBRI POLYMER	DOW SILICONES CORPORATION	10/11/2017	62/570748			
81806-JP-NP	Japan	COMPOSITION, COATING FILM USING THE SAME, SLIDING MEMBER HAVING THE COATING AND PROCESS FOR PRODUCING THE SAME	DOW SILICONES CORPORATION	06/11/2018	2018-111105			
81841-EP-EPA	European Procedure (Patents)	THERMOPLASTIC COMPOSITION	DOW SILICONES CORPORATION	04/05/2018	18305403.0			
DC10044-DE-EPT	Germany	Silicone Skin Adhesive Gels With Enhanced Adhesion To Plastic Substrates	DOW SILICONES CORPORATION	03/18/2005	05726039.0	1737504	06/09/2010	602005021767.3
DC10044-FI-EPT	Finland	Silicone Skin Adhesive Gels With Enhanced Adhesion To Plastic Substrates	DOW SILICONES CORPORATION	03/18/2005	05726039.0	1737504	06/09/2010	1737504
DC10044-FR-EPT	France	Silicone Skin Adhesive Gels With Enhanced Adhesion To Plastic Substrates	DOW SILICONES CORPORATION	03/18/2005	05726039.0	1737504	06/09/2010	1737504
DC10044-GB-EPT	United Kingdom	Silicone Skin Adhesive Gels With Enhanced Adhesion To Plastic Substrates	DOW SILICONES CORPORATION	03/18/2005	05726039.0	1737504	06/09/2010	1737504
DC10044-JP-PCT	Japan	Silicone Skin Adhesive Gels With Enhanced Adhesion To Plastic Substrates	DOW SILICONES CORPORATION	03/18/2005	2007-507334	2007-532179	10/28/2011	4849477
DC10119-CN-PCT	China	Composition Comprising Neopentasilane And Method Of Preparing Same	DOW SILICONES CORPORATION	08/29/2007	200780039179.X	101528813	10/26/2011	200780039179.X

DC10119-DE-EPT	Germany	Composition Comprising Neopentasilane And Method Of Preparing Same	DOW SILICONES CORPORATION	08/29/2007	07811642.3	2076558	04/18/2018	602007054612.5
DC10119-EP-EPT	European Procedure (Patents)	Composition Comprising Neopentasilane And Method Of Preparing Same	DOW SILICONES CORPORATION	08/29/2007	07811642.3	2076558	04/18/2018	2076558
DC10119-JP-PCT	Japan	Composition Comprising Neopentasilane And Method Of Preparing Same	DOW SILICONES CORPORATION	08/29/2007	2009-534570	2010507559	10/05/2012	5103480
DC10119-KR-PCT	SOUTH KOREA	Composition Comprising Neopentasilane And Method Of Preparing Same	DOW SILICONES CORPORATION	08/29/2007	20097008553		03/20/2015	1506136
DC10119-TW-NP	Taiwan	Composition Comprising Neopentasilane And Method Of Preparing Same	DOW SILICONES CORPORATION	09/12/2007	096134053	200821322	10/21/2013	I412530
DC10119-US-PCT	United States Of America	Composition Comprising Neopentasilane And Method Of Preparing Same	DOW SILICONES CORPORATION	08/29/2007	12/440299	20100176338	04/03/2012	8147789
DC10165-CN-PCT	China	Deposition Method Of Insulating Layers Having Low Dielectric Constant Of Semiconductor Device	DOW SILICONES CORPORATION	07/16/2002	02828976.5	1625799	05/30/2007	1319125
DC10165-JP-PCT	Japan	Deposition Method Of Insulating Layers Having Low Dielectric Constant Of Semiconductor Device	DOW SILICONES CORPORATION	07/16/2002	2004-506072	2005-526397	05/13/2009	4262676
DC10165-KR-NP	SOUTH KOREA	Deposition Method Of Insulating Layers Having Low Dielectric Constant Of Semiconductor Device	DOW SILICONES CORPORATION	05/17/2002	2002-0027413	2003-0089267	01/06/2009	0878270
DC10165-US-NP	United States Of America	Deposition Method Of Insulating Layers Having Low Dielectric Constant Of Semiconductor Device	DOW SILICONES CORPORATION	05/17/2002	10/150480	20030215970	01/10/2006	6984594
DC10284-BE-ETD	Belgium	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11173988.4	2383502	11/20/2013	2383502
DC10284-BE-ETD[2]	Belgium	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11174007.2	2383503	05/29/2013	2383503
DC10284-CN-PCT	China	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	200680043332.1	101313168	04/03/2013	200680043332.1
DC10284-DE-EPT	Germany	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	06826606.3	1952052	08/27/2014	602006042876.6
DC10284-DE-ETD	Germany	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11173988.4	2383502	11/20/2013	602006039391.1
DC10284-DE-ETD[2]	Germany	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11174007.2	2383503	05/29/2013	602006036619.1
DC10284-EP-ETD	European Procedure (Patents)	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11173988.4	2383502	11/20/2013	2383502
DC10284-EP-ETD[2]	European Procedure (Patents)	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11174007.2	2383503	05/29/2013	2383503
DC10284-FR-EPT	France	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	06826606.3	1952052	08/27/2014	1952052
DC10284-FR-ETD	France	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11173988.4	2383502	11/20/2013	2383502
DC10284-FR-ETD[2]	France	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	11174007.2	2383503	05/29/2013	2383503
DC10284-GB-EPT	United Kingdom	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	06826606.3	1952052	08/27/2014	1952052
DC10284-JP-PCT	Japan	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	2008536620	2009512506	06/21/2013	5296546
DC10284-US-PCT	United States Of America	Fluid Transfer Assembly	DOW SILICONES CORPORATION	10/23/2006	12/090815	20080277926	04/23/2013	8424923
DC10385-CN-PCT	China	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	200780029255.9	101501088	11/30/2011	200780029255.9
DC10385-DE-EPT	Germany	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	07809357.2	2024406	08/01/2012	602007024394.7
		A Silicone Acrylate Hybrid Composition						

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DC10385-DK-EPT	Denmark	and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	07809357.2	2024406	08/01/2012	2024406
DC10385-FR-EPT	France	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	07809357.2	2024406	08/01/2012	2024406
DC10385-GB-EPT	United Kingdom	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	07809357.2	2024406	08/01/2012	2024406
DC10385-IN-NP	India	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	10/20/2012	4382/CHE/2012			
DC10385-IN-NP[2]	India	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	11/28/2012	4958/CHE/2012			
DC10385-IN-PCT	India	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	4944/KOLNP/2008		05/08/2015	266477
DC10385-JP-DIV	Japan	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	08/02/2013	2013161212	2014-015614	11/28/2014	5654100
DC10385-JP-NP	Japan	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	10/22/2012	2012-233020	2013-087289	03/17/2017	6108759
DC10385-KR-NP	SOUTH KOREA	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	10/22/2012	2012-0117546	2013-0044380		
DC10385-KR-NP[2]	SOUTH KOREA	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	11/29/2012	2012-0137365	2013-0060161		
DC10385-KR-PCT	SOUTH KOREA	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	20087030476		08/14/2014	1432698
DC10385-SE-EPT	Sweden	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	07809357.2	2024406	08/01/2012	2024406
DC10385-US-CIP	United States Of America	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	10/21/2011	13/278979	20120108560	10/29/2013	8569416
DC10385-US-CIP[2]	United States Of America	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	11/29/2011	13/306467	20120114737	12/24/2013	8614278
DC10385-US-PCT	United States Of America	A Silicone Acrylate Hybrid Composition and Method of Making Same	DOW SILICONES CORPORATION	06/06/2007	12/303362	20090196911	02/28/2012	8124689
DC10449-AT-EPT	Austria	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	07810534.3	2044244	05/08/2013	2044244
DC10449-CA-PCT	Canada	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	2657929		11/04/2014	2657929
DC10449-CN-DIV	China	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	201210002807.X	102517631A	04/01/2015	201210002807.X
DC10449-DE-EPT	Germany	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	07810534.3	2044244	05/08/2013	602007030360.5
DC10449-FR-EPT	France	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	07810534.3	2044244	05/08/2013	2044244
DC10449-GB-EPT	United Kingdom	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	07810534.3	2044244	05/08/2013	2044244

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DC10449-IT-EPT	Italy	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	07810534.3	2044244	05/08/2013	502013902181744
DC10449-JP-PCT	Japan	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	2009520806	2009544171		
DC10449-KR-PCT	SOUTH KOREA	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	20097001023		07/08/2014	101419279
DC10449-SE-EPT	Sweden	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	07/17/2007	07810534.3	2044244	05/08/2013	2044244
DC10449-US-CIP	United States Of America	Method of Manufacturing Substrates Having Improved Carrier Lifetimes	DOW SILICONES CORPORATION	01/18/2013	13/745066	20140203297	05/10/2016	9337027
DC10657-JP-PCT	Japan	Method to Manufacture Large Uniform Ingots of Silicon Carbide by Sublimation/Condensation Processes	DOW SILICONES CORPORATION	10/08/2008	2010538004	2011506253	04/18/2014	5524855
DC10657-KR-PCT	SOUTH KOREA	Method to Manufacture Large Uniform Ingots of Silicon Carbide by Sublimation/Condensation Processes	DOW SILICONES CORPORATION	10/08/2008	20107014917	20100100944	10/29/2015	101566020
DC10657-RU-PCT	Russian Federation	Method to Manufacture Large Uniform Ingots of Silicon Carbide by Sublimation/Condensation Processes	DOW SILICONES CORPORATION	10/08/2008	2010123917		10/10/2013	2495163
DC10657-SG-PCT	Singapore	Method to Manufacture Large Uniform Ingots of Silicon Carbide by Sublimation/Condensation Processes	DOW SILICONES CORPORATION	10/08/2008	201004127.5		03/28/2013	162266
DC10657-TW-NP	Taiwan	Method to Manufacture Large Uniform Ingots of Silicon Carbide by Sublimation/Condensation Processes	DOW SILICONES CORPORATION	10/09/2008	097139066	200932964	06/21/2014	I441963
DC10657-US-PCT	United States Of America	Method to Manufacture Large Uniform Ingots of Silicon Carbide by Sublimation/Condensation Processes	DOW SILICONES CORPORATION	10/08/2008	12/744532	20120114545	07/01/2014	8765091
DC10684-BR-PCT	Brazil	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	PI0911885-3			
DC10684-DE-EPT	Germany	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	09745803.8	2276815	12/27/2017	602009050110.0
DC10684-EP-EPT	European Procedure (Patents)	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	09745803.8	2276815	12/27/2017	2276815
DC10684-FR-EPT	France	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	09745803.8	2276815	12/27/2017	2276815
DC10684-IT-EPT	Italy	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	09745803.8	2276815	12/27/2017	502018000009102
DC10684-JP-PCT	Japan	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	2011-508926	2011-522912	09/19/2014	5615806
DC10684-KR-PCT	SOUTH KOREA	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	2010-7025162			
DC10684-NL-EPT	Netherlands	Process For Reduction Of Friction	DOW SILICONES CORPORATION	05/14/2009	09745803.8	2276815	12/27/2017	2276815
DC10730-DE-EPT	Germany	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/29/2009	09744574.6	2351102	08/20/2014	602009026143.6
DC10730-FR-EPT	France	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/29/2009	09744574.6	2351102	08/20/2014	2351102

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DC10730-JP-DIV	Japan	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/29/2009	2012-236740		03/28/2014	5509293
DC10730-KR-DIV	SOUTH KOREA	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/29/2012	2012-7026755	2012-7026755	05/24/2016	101625545
DC10730-NL-EPT	Netherlands	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/29/2009	09744574.6	2351102	08/20/2014	2351102
DC10730-TW-DIV	Taiwan	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/30/2009	101138811	201308643	12/11/2015	I513025
DC10730-TW-DIV[2]	Taiwan	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/30/2009	101138810		11/11/2015	I508317
DC10730-TW-NP	Taiwan	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	10/30/2009	098137024		11/11/2015	I508313
DC10730-US-CNT	United States Of America	Photovoltaic Cell Module and Method of Forming	DOW SILICONES CORPORATION	02/25/2015	14/630998	2015-0171249	12/12/2017	9842952
DC10739-CN-PCT	China	Method of Reducing Memory Effects in Semiconductor Epitaxy	DOW SILICONES CORPORATION	05/29/2009	200980120374.4	102057078A	04/01/2015	200980120374.4
DC10739-JP-PCT	Japan	Method of Reducing Memory Effects in Semiconductor Epitaxy	DOW SILICONES CORPORATION	05/29/2009	2011-512535	2011-523214	02/21/2014	5478616
DC10739-RU-PCT	Russian Federation	Method of Reducing Memory Effects in Semiconductor Epitaxy	DOW SILICONES CORPORATION	05/29/2009	2010149457		04/22/2014	2520283
DC10739-SG-PCT	Singapore	Method of Reducing Memory Effects in Semiconductor Epitaxy	DOW SILICONES CORPORATION	05/29/2009	201008219-6		05/31/2013	166904
DC10739-TW-NP	Taiwan	Method of Reducing Memory Effects in Semiconductor Epitaxy	DOW SILICONES CORPORATION	06/04/2009	098118587	201013754	06/21/2013	I399795
DC10739-US-PCT	United States Of America	Method of Reducing Memory Effects in Semiconductor Epitaxy	DOW SILICONES CORPORATION	05/29/2009	12/993938	20110073874	01/01/2013	8343854
DC10794-CN-PCD	China	CVD Precursors	DOW SILICONES CORPORATION	08/11/2009	201310392992.2	103467506	03/23/2016	201310392992.2
DC10794-CN-PCT	China	CVD Precursors	DOW SILICONES CORPORATION	08/11/2009	200980141783.2	102187011	04/09/2014	200980141783.2
DC10794-DE-EPT	Germany	CVD Precursors	DOW SILICONES CORPORATION	08/11/2009	09822363.9	2373830	04/30/2014	602009023746.2
DC10794-JP-PCD	Japan	CVD Precursors	DOW SILICONES CORPORATION	08/30/2013	2013-179767		10/02/2015	5816235
DC10794-JP-PCT	Japan	CVD Precursors	DOW SILICONES CORPORATION	08/11/2009	2011-532103	2012-506147	03/07/2014	5491512
DC10794-KR-PCD	SOUTH KOREA	CVD Precursors	DOW SILICONES CORPORATION	03/03/2016	2016-7005023		07/07/2016	10-1639432
DC10794-KR-PCT	SOUTH KOREA	CVD Precursors	DOW SILICONES CORPORATION	08/11/2009	2011-7011237	2011-0084517		
DC10794-SG-PCT	Singapore	CVD Precursors	DOW SILICONES CORPORATION	08/11/2009	201102595-4		10/31/2013	170407
DC10794-TW-NP	Taiwan	CVD Precursors	DOW SILICONES CORPORATION	09/10/2009	098130566	201016878	01/11/2015	I468542
DC10794-US-CNT	United States Of America	CVD Precursors	DOW SILICONES CORPORATION	05/19/2014	14/280770	20140256159	08/25/2015	9117664
DC10794-US-PCT	United States Of America	CVD Precursors	DOW SILICONES CORPORATION	08/11/2009	13/122745	20110195582	07/08/2014	8772524
DC10924-CN-PCT	China	Film Forming, Silicone Containing Compositions	DOW SILICONES CORPORATION	07/02/2010	201080022977.3	102449073	11/13/2013	201080022977.3
DC10924-DE-EPT	Germany	Film Forming, Silicone Containing Compositions	DOW SILICONES CORPORATION	07/02/2010	10731884.2	2449031	06/04/2014	602010016447.0
DC10924-FR-EPT	France	Film Forming, Silicone Containing Compositions	DOW SILICONES CORPORATION	07/02/2010	10731884.2	2449031	06/04/2014	2449031
DC10924-GB-EPT	United Kingdom	Film Forming, Silicone Containing Compositions	DOW SILICONES CORPORATION	07/02/2010	10731884.2	2449031	06/04/2014	2449031
DC10924-US-PCT	United States Of America	Film Forming, Silicone Containing Compositions	DOW SILICONES CORPORATION	07/02/2010	13/379893	20120095109	08/04/2015	9096721
DC11350-CN-PCT	China	Topical Formulation Compositions Containing Silicone Based Excipients To Deliver Actives To A Substrate	DOW SILICONES CORPORATION	03/11/2013	201380021411.2	104271160	08/08/2017	201380021411.2
DC11350-EP-EPT	European Procedure (Patents)	Topical Formulation Compositions Containing Silicone Based Excipients To Deliver Actives To A Substrate	DOW SILICONES CORPORATION	03/11/2013	13713613.1	2841106A		
		Topical Formulation						

DC11350-JP-PCT	Japan	Compositions Containing Silicone Based Excipients To Deliver Actives To A Substrate	DOW SILICONES CORPORATION	03/11/2013	2015-508959	2015-514801	02/17/2017	6093007
DC11353-CN-PCT	China	Solid State Light And Method Of Forming	DOW SILICONES CORPORATION	12/20/2012	201280070705.X	104204119	10/12/2016	201280070705.X
DC11353-DE-EPT	Germany	Solid State Light And Method Of Forming	DOW SILICONES CORPORATION	12/20/2012	12813672.8	2798024	07/20/2016	602012020823.6
DC11353-JP-PCT	Japan	Solid State Light And Method Of Forming	DOW SILICONES CORPORATION	12/20/2012	2014-550382	2015-510257	09/09/2016	6001676
DC11353-KR-PCT	SOUTH KOREA	Solid State Light And Method Of Forming	DOW SILICONES CORPORATION	12/20/2012	2014-7021246			
DC11353-US-PCT	United States Of America	Solid State Light And Method Of Forming	DOW SILICONES CORPORATION	12/20/2012	14/369981	20150001567	04/07/2015	9000472
DC11357-CN-PCT	China	Method Of Forming A Light Transmitting Sheet Of A Solid State Light	DOW SILICONES CORPORATION	01/16/2013	201380013063.4	104159726	01/18/2017	2013800130634
DC11357-EP-EPT	European Procedure (Patents)	Method Of Forming A Light Transmitting Sheet Of A Solid State Light	DOW SILICONES CORPORATION	01/16/2013	13703193.6	2804747		
DC11357-JP-PCT	Japan	Method Of Forming A Light Transmitting Sheet Of A Solid State Light	DOW SILICONES CORPORATION	01/16/2013	2014-552390	2015-513328	03/23/2018	6309898
DC11357-KR-PCT	SOUTH KOREA	Method Of Forming A Light Transmitting Sheet Of A Solid State Light	DOW SILICONES CORPORATION	01/16/2013	2014-702437			
DC11357-US-PCT	United States Of America	OPTICAL ARTICLE AND METHOD OF FORMING	DOW SILICONES CORPORATION	01/16/2013	14/372465	20150290887	06/27/2017	9688035
DC11374-CN-PCT	China	Curable Compositions Of Resin-Linear Organosiloxane Block Copolymers	DOW SILICONES CORPORATION	12/14/2012	201280069712.8	104114656A	08/25/2017	201280069712.8
DC11374-DE-EPT	Germany	Curable Compositions Of Resin-Linear Organosiloxane Block Copolymers	DOW SILICONES CORPORATION	12/14/2012	12815889.6	2791263	08/31/2016	602012022476.2
DC11374-JP-PCT	Japan	Curable Compositions Of Resin-Linear Organosiloxane Block Copolymers	DOW SILICONES CORPORATION	12/14/2012	2014-547475			
DC11374-KR-PCT	SOUTH KOREA	Curable Compositions Of Resin-Linear Organosiloxane Block Copolymers	DOW SILICONES CORPORATION	12/14/2012	10-2014-7018537			
DC11374-NL-EPT	Netherlands	Curable Compositions Of Resin-Linear Organosiloxane Block Copolymers	DOW SILICONES CORPORATION	12/14/2012	12815889.6	2791263	08/31/2016	2791263
DC11374-US-PCT	United States Of America	Curable Compositions Of Resin-Linear Organosiloxane Block Copolymers	DOW SILICONES CORPORATION	12/14/2012	14/364654	20140357827	05/16/2017	9650472
DC11462-US-PCT	United States Of America	Curable Compositions Of Resin-Linear Organosiloxane Block Copolymers	DOW SILICONES CORPORATION	03/14/2013	14/386213	20150112011	11/03/2015	9175140
DC11520-CN-PCT	China	Photovoltaic Cell Module	DOW SILICONES CORPORATION	11/12/2013	201380057948.4	104769729	08/29/2017	201380057948.4
DC11520-DE-EPT	Germany	Photovoltaic Cell Module	DOW SILICONES CORPORATION	11/12/2013	13795398.0	2917943	10/05/2016	602013012539.2
DC11520-JP-PCT	Japan	Photovoltaic Cell Module	DOW SILICONES CORPORATION	11/12/2013	2015542009	2016-504758		
DC11520-KR-PCT	SOUTH KOREA	Photovoltaic Cell Module	DOW SILICONES CORPORATION	11/12/2013	10-2015-7012077	2015-0084826		
DC11521-CN-PCT	China	Method Of Forming An Electronic Article	DOW SILICONES CORPORATION	11/12/2013	201380057521.4	104769043	08/08/2017	201380057521.4

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DC11521-EP-EPT	European Procedure (Patents)	Method Of Forming An Electronic Article	DOW SILICONES CORPORATION	11/12/2013	13798474.6	2917282		
DC11521-JP-PCD	Japan	Method Of Forming An Electronic Article	DOW SILICONES CORPORATION	11/12/2013	2018-76050			
DC11521-JP-PCT	Japan	Method Of Forming An Electronic Article	DOW SILICONES CORPORATION	11/12/2013	2015542016		07/06/2018	6363089
DC11521-KR-PCT	SOUTH KOREA	Method Of Forming An Electronic Article	DOW SILICONES CORPORATION	11/12/2013	20157012116			
DC11521-US-PCT	United States Of America	Method Of Forming An Electronic Article	DOW SILICONES CORPORATION	11/12/2013	14/440754	20150263208	04/12/2016	9312416
DC11526-CN-PCT	China	Flat SiC Semiconductor Substrate	DOW SILICONES CORPORATION	09/10/2013	201380060888.1	4813439A	04/12/2017	20138006888.1
DC11526-DE-EPT	Germany	Flat SiC Semiconductor Substrate	DOW SILICONES CORPORATION	09/10/2013	13765897.7	2912681	10/26/2016	602013013271.2
DC11526-FR-EPT	France	Flat SiC Semiconductor Substrate	DOW SILICONES CORPORATION	09/10/2013	13765897.7	2912681	10/26/2016	2912681
DC11526-GB-EPT	United Kingdom	Flat SiC Semiconductor Substrate	DOW SILICONES CORPORATION	09/10/2013	13765897.7	2912681	10/26/2016	2912681
DC11526-IT-EPT	Italy	Flat SiC Semiconductor Substrate	DOW SILICONES CORPORATION	09/10/2013	13765897.7	2912681	10/26/2016	502017000006480
DC11526-US-DIV	United States Of America	Flat SiC Semiconductor Substrate	DOW SILICONES CORPORATION	03/11/2015	14/644980	20150194319	10/20/2015	9165779
DC11526-US-NP	United States Of America	Flat SiC Semiconductor Substrate	DOW SILICONES CORPORATION	08/06/2013	13/959896	20140117380	04/28/2015	9018639
DC11571-CN-PCT	China	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	201380047978.7	4769016A	06/23/2017	201380047978.7
DC11571-DE-EPT	Germany	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-EP-EPT	European Procedure (Patents)	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-ES-EPT	Spain	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-FR-EPT	France	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-GB-EPT	United Kingdom	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-IT-EPT	Italy	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	502018000024656
DC11571-KR-PCT	SOUTH KOREA	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	10-2015-7009956			
DC11571-NL-EPT	Netherlands	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-PL-EPT	Poland	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-SE-EPT	Sweden	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-TR-EPT	Turkey	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	13766015.5	2898002	05/23/2018	2898002
DC11571-US-PCT	United States Of America	Production Of Blend Of Polyolefin And Organopolysiloxane	DOW SILICONES CORPORATION	09/19/2013	14/429004	20150225557	12/27/2016	9527988
DC11578-CN-PCT	China	High Voltage Power Semiconductor Devices On SiC	DOW SILICONES CORPORATION	09/10/2013	201380020805.6	4246979A	11/23/2016	201380020805.6
DC11578-KR-PCT	SOUTH KOREA	High Voltage Power Semiconductor Devices On SiC	DOW SILICONES CORPORATION	09/10/2013	20147027127		07/22/2015	1539927
DC11578-US-CNT	United States Of America	High Voltage Power Semiconductor Devices On SiC	DOW SILICONES CORPORATION	09/16/2014	14/487774	20150333125	05/10/2016	9337277
DC11578-US-NP	United States Of America	High Voltage Power Semiconductor Devices On SiC	DOW SILICONES CORPORATION	08/06/2013	13/959855	20140070234	10/14/2014	8860040

DC11629-CN-PCT	China	2-Aminoimidazole-Functional Silicone Compositions And Methods Of Making The Same	DOW SILICONES CORPORATION	03/13/2014	201480014328.7	105189672	08/25/2017	201480014328.7
DC11629-DE-EPT	Germany	2-Aminoimidazole-Functional Silicone Compositions And Methods Of Making The Same	DOW SILICONES CORPORATION	03/13/2014	14720790.6	2970715	10/26/2016	602014004499.9
DC11629-FR-EPT	France	2-Aminoimidazole-Functional Silicone Compositions And Methods Of Making The Same	DOW SILICONES CORPORATION	03/13/2014	14720790.6	2970715	10/26/2016	2970715
DC11629-GB-EPT	United Kingdom	2-Aminoimidazole-Functional Silicone Compositions And Methods Of Making The Same	DOW SILICONES CORPORATION	03/13/2014	14720790.6	2970715	10/26/2016	2970715
DC11629-KR-PCT	SOUTH KOREA	2-Aminoimidazole-Functional Silicone Compositions And Methods Of Making The Same	DOW SILICONES CORPORATION	03/13/2014	2015-7025344			
DC11629-US-PCT	United States Of America	2-Aminoimidazole-Functional Silicone Compositions And Methods Of Making The Same	DOW SILICONES CORPORATION	03/13/2014	14/773762	20160024257	08/23/2016	9422404
DC11662-CN-PCT	China	SIC Crystal and Wafer Cut from Crystal with Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	201380074914.6			
DC11662-EP-EPT	European Procedure (Patents)	SIC Crystal and Wafer Cut from Crystal with Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	13824055.1	2954101		
DC11662-JP-PCT	Japan	SIC Crystal and Wafer Cut from Crystal with Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	2015-556013	2016-506902		
DC11662-KR-PCT	SOUTH KOREA	SIC Crystal and Wafer Cut from Crystal with Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	10-2015-7024105			
DC11662-US-DIV	United States Of America	SIC Crystal and Wafer Cut from Crystal with Low Dislocation Density	DOW SILICONES CORPORATION	01/30/2017	15/419993	20170137963		
DC11662-US-NP	United States Of America	SIC Crystal and Wafer Cut from Crystal with Low Dislocation Density	DOW SILICONES CORPORATION	10/18/2013	14/058167	20140220296	10/24/2017	9797064
DC11663-CN-PCT	China	Method To Reduce Dislocations in SIC Crystal Growth	DOW SILICONES CORPORATION	12/20/2013	201380074938.1	5189835A	05/24/2017	201380074938.1
DC11663-EP-EPT	European Procedure (Patents)	Method To Reduce Dislocations in SIC Crystal Growth	DOW SILICONES CORPORATION	12/20/2013	13818955.0	2943602		
DC11663-JP-PCT	Japan	Method To Reduce Dislocations in SIC Crystal Growth	DOW SILICONES CORPORATION	12/20/2013	2015-556941	2016-507462	02/09/2018	6285963
DC11663-KR-PCT	SOUTH KOREA	Method To Reduce Dislocations in SIC Crystal Growth	DOW SILICONES CORPORATION	12/20/2013	2015-7024047	2015-0107895	06/27/2016	1016354380000
DC11663-US-NP	United States Of America	Method To Reduce Dislocations in SIC Crystal Growth	DOW SILICONES CORPORATION	07/08/2013	13/937149	20140220325	04/28/2015	9017804
DC11664-CN-PCT	China	SIC Crystal With Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	201380074470.6	5008596A		
DC11664-EP-EPT	European Procedure (Patents)	SIC Crystal With Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	13821355.8	2954100		
DC11664-JP-PCT	Japan	SIC Crystal With Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	2015-556014	2016-508948		
DC11664-KR-PCT	SOUTH KOREA	SIC Crystal With Low Dislocation Density	DOW SILICONES CORPORATION	12/20/2013	2015-024104	2015-116885		
DC11664-US-DIV	United States Of America	SIC Crystal With Low Dislocation Density	DOW SILICONES CORPORATION	01/31/2017	15/421220			
DC11664-US-NP	United States Of America	SIC Crystal With Low Dislocation Density	DOW SILICONES CORPORATION	08/09/2013	13/963989	20140220298	08/22/2017	9738991
DC11726-CN-PCT	China	Silicone Acrylate Compositions And Methods Of Preparing The Same	DOW SILICONES CORPORATION	01/29/2016	201680015769.8			

DC11726-EP-EPT	European Procedure (Patents)	Silicone Acrylate Compositions And Methods Of Preparing The Same	DOW SILICONES CORPORATION	01/29/2016	16744149.2	3250618		
DC11726-IN-PCT	India	Silicone Acrylate Compositions And Methods Of Preparing The Same	DOW SILICONES CORPORATION	01/29/2016	201717027908	201717027908		
DC11726-JP-PCT	Japan	Silicone Acrylate Compositions And Methods Of Preparing The Same	DOW SILICONES CORPORATION	01/29/2016	2017-538574			
DC11726-KR-PCT	SOUTH KOREA	Silicone Acrylate Compositions And Methods Of Preparing The Same	DOW SILICONES CORPORATION	01/29/2016	10-2017-7023044	10-2017-0106428		
DC11726-US-PCT	United States Of America	Silicone Acrylate Compositions And Methods Of Preparing The Same	DOW SILICONES CORPORATION	01/29/2016	15/532362	20170368179		
DC11727-CN-PCT	China	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	02/21/2014	201480020682.0	105121556		
DC11727-DE-EPT	Germany	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	02/21/2014	14708752.2	2958961	05/16/2018	602014025503.5
DC11727-EP-EPT	European Procedure (Patents)	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	02/21/2014	14708752.2	2958961	05/16/2018	2958961
DC11727-JP-PCT	Japan	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	02/21/2014	2015-558990		03/02/2018	6297070
DC11727-KR-PCD	SOUTH KOREA	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	10/07/2016	10-2016-7024814			
DC11727-KR-PCT	SOUTH KOREA	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	02/21/2014	10-2015-7022361		06/08/2017	10-1747160
DC11727-TW-NP	Taiwan	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	02/21/2014	103105947	201439220	08/01/2018	I631185
DC11727-US-PCT	United States Of America	Silicone Resin Composition For LED Devices	DOW SILICONES CORPORATION	02/21/2014	14/769131	20150376344	02/27/2018	9902811
DC11734-CN-PCT	China	Method Of Producing A Silicone Masterbatch Composition Having High Scratch Resistance Properties	DOW SILICONES CORPORATION	03/02/2015	201580014989.4	106103577A		
DC11734-EP-EPT	European Procedure (Patents)	Method Of Producing A Silicone Masterbatch Composition Having High Scratch Resistance Properties	DOW SILICONES CORPORATION	03/02/2015	15707619.1	3114168		
DC11734-GB-NP	United Kingdom	Method Of Producing A Silicone Masterbatch Composition Having High Scratch Resistance Properties	DOW SILICONES CORPORATION	12/02/2014	1421634.5			
DC11734-IN-PCT	India	Method Of Producing A Silicone Masterbatch Composition Having High Scratch Resistance Properties	DOW SILICONES CORPORATION	03/02/2015	201617033637			
DC11734-JP-PCT	Japan	Method Of Producing A Silicone Masterbatch Composition Having High Scratch Resistance Properties	DOW SILICONES CORPORATION	03/02/2015	2016-572895			
DC11734-KR-PCT	SOUTH KOREA	Method Of Producing A Silicone Masterbatch Composition Having High Scratch Resistance Properties	DOW SILICONES CORPORATION	03/02/2015	10-2016-7027516	10-2016-0141746		
DC11734-RU-PCT	Russian Federation	Method Of Producing A Silicone Masterbatch Composition Having High Scratch Resistance Properties	DOW SILICONES CORPORATION	03/02/2015	2016136182	2016136182		
DC11734-US-PCT	United States Of America	THERMOPLASTIC POLYMER MASTERBATCH	DOW SILICONES CORPORATION	03/02/2015	15/123278	20170058114		
DC11735-CN-PCT	China	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	201480002722.9	4718601A	04/26/2017	201480002722.9
DC11735-DE-EPT	Germany	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	14721146.0	2837020	05/17/2017	2837020

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DC11735-ES-EPT	Spain	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	14721146.0	2837020	05/17/2017	2837020
DC11735-FI-EPT	Finland	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	14721146.0	2837020	05/17/2017	2837020
DC11735-FR-EPT	France	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	14721146.0	2837020	05/17/2017	2837020
DC11735-GB-EPT	United Kingdom	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	14721146.0	2837020	05/17/2017	2837020
DC11735-IT-EPT	Italy	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	14721146.0	2837020	05/17/2017	502017000093402
DC11735-JP-PCT	Japan	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	2015-523311	2015-529015	06/24/2016	5955463
DC11735-KR-PCT	SOUTH KOREA	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	2015-7008990	2015-0052304	06/17/2016	1016329470000
DC11735-SE-EPT	Sweden	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/15/2014	14721146.0	2837020	05/17/2017	2837020
DC11735-US-PCT	United States Of America	SiC Substrate With SiC Epitaxial Film	DOW SILICONES CORPORATION	03/14/2014	14/213888	20140264384	01/27/2015	8940614
DC11810-EP-EPT	European Procedure (Patents)	Curable Silicone Composition, Cured Product Thereof, And Optical Semiconductor Device	DOW SILICONES CORPORATION	08/26/2014	14840431.2	3039079		
DC11814-CN-PCT	China	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	09/03/2014	201480054107.2	105593233	04/27/2018	201480054107.2
DC11814-DE-EPT	Germany	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	09/03/2014	14766329.8	3041850	11/15/2017	602014017294.6
DC11814-EP-EPT	European Procedure (Patents)	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	09/03/2014	14766329.8	3041850	11/15/2017	3041850
DC11814-JP-PCT	Japan	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	09/03/2014	2016-540322			
DC11814-KR-PCT	SOUTH KOREA	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	09/03/2014	2016-7008588	2016-0052631		
DC11814-TW-NP	Taiwan	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	09/01/2014	103130048	201518210	09/01/2018	1634073
DC11814-US-CIP	United States Of America	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	11/10/2017	15/809431	20180066140		
DC11814-US-PCT	United States Of America	2,2,4,4-Tetrasilylpentasilane And Its Compositions, Methods And Uses	DOW SILICONES CORPORATION	09/03/2014	14/915404	20160207784	03/27/2018	9926203
DC11842-CN-PCT	China	Anti-Friction Coating For Dry Lubrication Of Engine Fasteners	DOW SILICONES CORPORATION	12/18/2014	201480071817.6	105873975A		
DC11842-EP-EPT	European Procedure (Patents)	Anti-Friction Coating For Dry Lubrication Of Engine Fasteners	DOW SILICONES CORPORATION	12/18/2014	14825135.8	3083750		
DC11842-JP-PCT	Japan	Anti-Friction Coating For Dry Lubrication Of Engine Fasteners	DOW SILICONES CORPORATION	12/18/2014	2016-541435			
DC11842-KR-PCT	SOUTH KOREA	Anti-Friction Coating For Dry Lubrication Of Engine Fasteners	DOW SILICONES CORPORATION	12/18/2014	2016-7018801			
DC11842-US-PCT	United States Of America	Anti-Friction Coating For Dry Lubrication Of Engine Fasteners	DOW SILICONES CORPORATION	12/18/2014	15/105943	20160319211		
DC11847-CN-PCT	China	Low Friction Resistance Polyoxymethylene Composition	DOW SILICONES CORPORATION	03/26/2015	201580016341.0	106133053		
DC11847-EP-EPT	European Procedure (Patents)	Low Friction Resistance Polyoxymethylene Composition	DOW SILICONES CORPORATION	03/26/2015	15712153.4	3126445		
DC11847-JP-PCT	Japan	Low Friction Resistance Polyoxymethylene Composition	DOW SILICONES CORPORATION	03/26/2015	2016-559988			
DC11847-KR-PCT	SOUTH KOREA	Low Friction Resistance Polyoxymethylene Composition	DOW SILICONES CORPORATION	03/26/2015	10-2016-7027388			

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DC11847-US-PCT	United States Of America	THERMOPLASTIC POLYMER COMPOSITIONS HAVING LOW FRICTION RESISTANCE	DOW SILICONES CORPORATION	03/26/2015	15/300485	20170114188		
DC11862-CN-PCT	China	Reactive Silicone Composition, Hotmelt Material Made Therefrom, And Curable Hotmelt Composition	DOW SILICONES CORPORATION	02/16/2015	201580006866.6	105960437		
DC11862-DE-EPT	Germany	Reactive Silicone Composition, Hotmelt Material Made Therefrom, And Curable Hotmelt Composition	DOW SILICONES CORPORATION	02/16/2015	15751816.8	3107965		
DC11862-EP-EPT	European Procedure (Patents)	Reactive Silicone Composition, Hotmelt Material Made Therefrom, And Curable Hotmelt Composition	DOW SILICONES CORPORATION	02/16/2015	15751816.8	3107965		
DC11862-JP-PCT	Japan	Reactive Silicone Composition, Hotmelt Material Made Therefrom, And Curable Hotmelt Composition	DOW SILICONES CORPORATION	02/16/2015	2016-552907			
DC11862-KR-PCT	SOUTH KOREA	Reactive Silicone Composition, Hotmelt Material Made Therefrom, And Curable Hotmelt Composition	DOW SILICONES CORPORATION	02/16/2015	10-2016-7025054			
DC11862-TW-NP	Taiwan	Reactive Silicone Composition, Hotmelt Material Made Therefrom, And Curable Hotmelt Composition	DOW SILICONES CORPORATION	02/17/2015	104105740	201536866	07/01/2018	I628236
DC11862-US-PCT	United States Of America	Reactive Silicone Composition, Hotmelt Material Made Therefrom, And Curable Hotmelt Composition	DOW SILICONES CORPORATION	02/16/2015	15/115923	20170166701	09/05/2017	9751988
DC11919-KR-PCT	SOUTH KOREA	Process Of Synthesizing Diisopropylamino-Disilanes	DOW SILICONES CORPORATION	05/29/2015	10-2016-7036883			
DC11919-US-PCT	United States Of America	Process Of Synthesizing Diisopropylamino-Disilanes	DOW SILICONES CORPORATION	05/29/2015	15/300987	20170029446	12/12/2017	9840523
DC11920-KR-PCT	SOUTH KOREA	Monoaminosilane Compounds	DOW SILICONES CORPORATION	05/29/2015	10-2016-7036446			
DC11920-KR-PCT[2]	SOUTH KOREA	Monoaminosilane Compounds	DOW SILICONES CORPORATION	05/29/2015	10-2016-7036880			
DC11920-US-PCT	United States Of America	Monoaminosilane Compounds	DOW SILICONES CORPORATION	05/29/2015	15/314323	20170114081	07/24/2018	10030038
DC11920-US-PCT[2]	United States Of America	DIAMINOSILANE COMPOUNDS	DOW SILICONES CORPORATION	05/29/2015	15/314300	20170129908	07/24/2018	10030037
DC11943-CN-PCT	China	Large Diameter Semiconductor Wafer For Integration With Power Device Manufacturing Technology	DOW SILICONES CORPORATION	07/29/2015	201580041581.6	106716596		
DC11943-EP-EPT	European Procedure (Patents)	METHOD OF MANUFACTURING LARGE DIAMETER SILICON CARBIDE CRYSTAL BY SUBLIMATION AND RELATED SEMICONDUCTOR SIC WAFER	DOW SILICONES CORPORATION	07/29/2015	15749909.6	3175475		
DC11943-JP-PCT	Japan	Large Diameter Semiconductor Wafer For Integration With Power Device Manufacturing Technology	DOW SILICONES CORPORATION	07/29/2015	2017-504645	2017-523950		

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DC11943-KR-PCT	SOUTH KOREA	Large Diameter Semiconductor Wafer For Integration With Power Device Manufacturing Technology	DOW SILICONES CORPORATION	07/29/2015	10-2014-7005000	10-2017-0041223		
DC11943-TW-NP	Taiwan	Large Diameter Semiconductor Wafer For Integration With Power Device Manufacturing Technology	DOW SILICONES CORPORATION	07/29/2015	104124497	2201611098		
DC11943-US-DIV	United States Of America	METHOD FOR MANUFACTURING SIC WAFER FIT FOR INTEGRATION WITH POWER DEVICE MANUFACTURING TECHNOLOGY	DOW SILICONES CORPORATION	03/04/2016	15/061959	20160189956	06/19/2018	10002760
DC11943-US-NP	United States Of America	METHOD FOR MANUFACTURING SIC WAFER FIT FOR INTEGRATION WITH POWER DEVICE MANUFACTURING TECHNOLOGY	DOW SILICONES CORPORATION	12/29/2014	14/585101	2016-0032486	03/08/2016	9279192
DC11948-CN-PCT	China	Pentachlorodisilane	DOW SILICONES CORPORATION	05/19/2016	201680028698.5	107614749		
DC11948-EP-EPT	European Procedure (Patents)	Pentachlorodisilane	DOW SILICONES CORPORATION	05/19/2016	16726733.5	3298177		
DC11948-JP-PCT	Japan	Pentachlorodisilane	DOW SILICONES CORPORATION	05/19/2016	2017-559637			
DC11948-KR-PCT	SOUTH KOREA	Pentachlorodisilane	DOW SILICONES CORPORATION	05/19/2016	10-2017-7035370	10-2018-0005221		
DC11948-TW-NP	Taiwan	Pentachlorodisilane	DOW SILICONES CORPORATION	05/20/2016	105115713	201704244		
DC11948-US-PCT	United States Of America	Pentachlorodisilane	DOW SILICONES CORPORATION	05/19/2016	15/558726	20180076025		
DC11950-CN-PCT	China	Aminohydridodisilanes	DOW SILICONES CORPORATION	05/15/2017	PCT/US17/032619			
DC11950-JP-PCT	Japan	Aminohydridodisilanes	DOW SILICONES CORPORATION	05/15/2017	PCT/US17/032619			
DC11950-KR-PCT	SOUTH KOREA	Aminohydridodisilanes	DOW SILICONES CORPORATION	05/15/2017	PCT/US17/032619			
DC11950-TW-NP	Taiwan	Aminohydridodisilanes	DOW SILICONES CORPORATION	05/16/2017	106116176	201806960		
DC11950-WO-PCT	International Procedure	Aminohydridodisilanes	DOW SILICONES CORPORATION	05/15/2017	PCT/US17/032619	WO/2017/200908		
DC11983-KR-NP	SOUTH KOREA	Silicon Precursor, Method Of Forming A Layer Using The Same And Method Of Fabricating A Semiconductor Device Using The Same	DOW SILICONES CORPORATION	04/16/2014	2014-0045575			
DC11983-KR-NP[2]	SOUTH KOREA	Silicon Precursor, Method Of Forming A Layer Using The Same And Method Of Fabricating A Semiconductor Device Using The Same	DOW SILICONES CORPORATION	04/15/2015	2015-0053180	10-2015-0120306		
DC11983-US-DIV	United States Of America	Silicon Precursor, Method Of Forming A Layer Using The Same And Method Of Fabricating A Semiconductor Device Using The Same	DOW SILICONES CORPORATION	07/29/2016	15/223685	20160336328	02/20/2018	9899392
DC11983-US-NP	United States Of America	Silicon Precursor, Method Of Forming A Layer Using The Same And Method Of Fabricating A Semiconductor Device Using The Same	DOW SILICONES CORPORATION	01/22/2015	14/602671	20150303060		
DC11984-CN-PCT	China	Multi-phase Silicone Acrylic Hybrid Visco-Elastic Compositions And Methods Of Making Same	DOW SILICONES CORPORATION	02/05/2016	201680017558.8			

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DC11984-EP-EPT	European Procedure (Patents)	Multi-phase Silicone Acrylic Hybrid Visco-Elastic Compositions And Methods Of Making Same	DOW SILICONES CORPORATION	02/05/2016	16749621.5	3256504
DC11984-JP-PCT	Japan	Multi-phase Silicone Acrylic Hybrid Visco-Elastic Compositions And Methods Of Making Same	DOW SILICONES CORPORATION	02/05/2016	2017-540800	
DC11984-KR-PCT	SOUTH KOREA	Multi-phase Silicone Acrylic Hybrid Visco-Elastic Compositions And Methods Of Making Same	DOW SILICONES CORPORATION	02/05/2016	10-2017-7024922	10-2017-0115582
DC11984-US-PCT	United States Of America	Multi-phase Silicone Acrylic Hybrid Visco-Elastic Compositions And Methods Of Making Same	DOW SILICONES CORPORATION	02/05/2016	15/545133	20180002583
DC11995-CN-PCT	China	Furnace for Seeded Sublimation of Wide Band Gap Crystals	DOW SILICONES CORPORATION	01/29/2016	201680008678.1	107223168
DC11995-EP-EPT	European Procedure (Patents)	Furnace for Seeded Sublimation of Wide Band Gap Crystals	DOW SILICONES CORPORATION	01/29/2016	16707276.8	
DC11995-JP-PCT	Japan	Furnace for Seeded Sublimation of Wide Band Gap Crystals	DOW SILICONES CORPORATION	01/29/2016	PCT/US16/015773	
DC11995-TW-NP	Taiwan	Furnace for Seeded Sublimation of Wide Band Gap Crystals	DOW SILICONES CORPORATION	02/03/2016	105103469	201638371
DC11995-US-PCT	United States Of America	Furnace for Seeded Sublimation of Wide Band Gap Crystals	DOW SILICONES CORPORATION	01/29/2016	15/548082	20180002828
DC12001-CN-PCT	China	Sulfur-Containing Polyorganosiloxane Compositions And Related Aspects	DOW SILICONES CORPORATION	11/06/2015	201580070450.0	107109067
DC12001-EP-EPT	European Procedure (Patents)	Sulfur-Containing Polyorganosiloxane Compositions And Related Aspects	DOW SILICONES CORPORATION	11/06/2015	15858244.5	3218424
DC12001-JP-PCT	Japan	Sulfur-Containing Polyorganosiloxane Compositions And Related Aspects	DOW SILICONES CORPORATION	11/06/2015	2017-525409	2018-505917
DC12001-KR-PCT	SOUTH KOREA.	Sulfur-Containing Polyorganosiloxane Compositions And Related Aspects	DOW SILICONES CORPORATION	11/06/2015	10-2017-7015760	10-2017-0083105
DC12001-TW-NP	Taiwan	Sulfur-Containing Polyorganosiloxane Compositions And Related Aspects	DOW SILICONES CORPORATION	10/23/2015	104134832	201631043
DC12001-US-PCT	United States Of America	Sulfur-Containing Polyorganosiloxane Compositions And Related Aspects	DOW SILICONES CORPORATION	11/06/2015	15/518332	20170306150
DC15010-CN-PCT	China	Synthesis of Disilanylamines through Transamination	DOW SILICONES CORPORATION	12/16/2016	201680072355.9	
DC15010-JP-PCT	Japan	Synthesis of Disilanylamines through Transamination	DOW SILICONES CORPORATION	12/16/2016	2018-530829	
DC15010-KR-PCT	SOUTH KOREA	Synthesis of Disilanylamines through Transamination	DOW SILICONES CORPORATION	12/16/2016	10-2018-7018306	
DC15010-TW-NP	Taiwan	SYNTHESIS OF DISILANYLAMINES AND POLYSILANYLAMINES	DOW SILICONES CORPORATION	12/16/2016	105141894	201733908
DC15010-US-PCT	United States Of America	Synthesis of Disilanylamines through Transamination	DOW SILICONES CORPORATION	12/16/2016	15/779653	US-2018-0258107-A1
DC16009-WO-PCT	International Procedure	POLYMER COMPOSITION	DOW SILICONES CORPORATION	06/02/2017	PCT/IB17/000848	WO/2017/208081
DC16017-JP-NP	Japan	Grease composition, mechanical article and starter overrunning clutches	DOW SILICONES CORPORATION	03/11/2016	2016-047995	2017-160373

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DC16043-TW-NP	Taiwan	TRICHLORODISILANE	DOW SILICONES CORPORATION	09/26/2017	106133001	201813927		
DC16043-WO-PCT	International Procedure	TRICHLORODISILANE	DOW SILICONES CORPORATION	09/21/2017	PCT/US17/052609	WO/2018/052609		
DC16044-EP-EPA	European Procedure (Patents)	METHOD OF MAKING ALUMINUM FREE NEOPENTASILANE	DOW SILICONES CORPORATION	06/21/2018	18179116.1			
DC16044-US-NP	United States Of America	METHOD OF MAKING ALUMINUM FREE NEOPENTASILANE	DOW SILICONES CORPORATION	06/11/2018	16/004802			
DC16054-TW-NP	Taiwan	CHLORODISILAZANES	DOW SILICONES CORPORATION	09/27/2017	106133216	201817908		
DC16054-WO-PCT	International Procedure	CHLORODISILAZANES	DOW SILICONES CORPORATION	09/21/2017	PCT/US17/52644	WO/2018/063907		
DC16061-TW-NP	Taiwan	SiH-FREE VINYLDISILANES	DOW SILICONES CORPORATION	09/19/2017	106132149	201829305		
DC16061-WO-PCT	International Procedure	SiH-FREE VINYLDISILANES	DOW SILICONES CORPORATION	09/15/2017	PCT/US17/051710	WO/2018/057411		
DC4525-MY-NP[2]	Malaysia	Thermoplastic Silicone Elastomers	DOW SILICONES CORPORATION	04/22/1998	9801794		05/31/2004	MY-117127-A
DC4648-JP-DIV	Japan	Method for Producing Hydrogenated Silicon Oxycarbide Films Having Low Dielectric Constant	DOW SILICONES CORPORATION	10/26/2009	2009245328	2010028130	12/09/2011	4881422
DC4648-KR-NP	SOUTH KOREA	Method for Producing Hydrogenated Silicon Oxycarbide Films Having Low Dielectric Constant	DOW SILICONES CORPORATION	05/27/1999	99/19173		10/11/2004	0453612
DC4648-TW-NP	Taiwan	Method for Producing Hydrogenated Silicon Oxycarbide Films Having Low Dielectric Constant	DOW SILICONES CORPORATION	05/13/1999	088107766	491910	06/21/2002	491910
DC4686-DE-EPA	Germany	Thermoplastic Silicone Vulcanizates Prepared by Condensation Cure	DOW SILICONES CORPORATION	09/16/1999	99118344.3	0994151	03/29/2006	69930571.3
DC4686-FR-EPA	France	Thermoplastic Silicone Vulcanizates Prepared by Condensation Cure	DOW SILICONES CORPORATION	09/16/1999	99118344.3	0994151	03/29/2006	0994151
DC4686-GB-EPA	United Kingdom	Thermoplastic Silicone Vulcanizates Prepared by Condensation Cure	DOW SILICONES CORPORATION	09/16/1999	99118344.3	0994151	03/29/2006	0994151
DC4686-JP-NP	Japan	Thermoplastic Silicone Vulcanizates Prepared by Condensation Cure	DOW SILICONES CORPORATION	10/07/1999	287053/99	109696/00	04/08/2011	4717976
DC4686-US-NP	United States Of America	Thermoplastic Silicone Vulcanizates Prepared by Condensation Cure	DOW SILICONES CORPORATION	10/07/1998	09/167337		11/28/2000	6153691
DC4737-CN-PCT	China	Fire Resistant Thermoplastic Silicone Vulcanizates	DOW SILICONES CORPORATION	01/31/2000	00803417.6	1339047A	01/14/2004	00803417.6
DC4737-DE-EPT	Germany	Fire Resistant Thermoplastic Silicone Vulcanizates	DOW SILICONES CORPORATION	01/31/2000	00910031.4	1153079	08/25/2004	60013252.8
DC4737-US-CNT	United States Of America	Fire Resistant Thermoplastic Silicone Vulcanizates	DOW SILICONES CORPORATION	06/13/2001	09/880480	2002-0055567	08/13/2002	6433049
DC4749-US-NP	United States Of America	Pressure Sensitive Adhesive Compositions for Transdermal Drug Delivery Devices	DOW SILICONES CORPORATION	02/06/1999	09/245687		01/08/2002	6337086
DC4844-CN-PCT	China	Thermoplastic Silicone Elastomers Formed From Nylon Resins	DOW SILICONES CORPORATION	03/21/2001	01807264.X	1446249A	03/23/2005	01807264.X
DC4844-DE-EPT	Germany	Thermoplastic Silicone Elastomers Formed From Nylon Resins	DOW SILICONES CORPORATION	03/21/2001	01920590.5	1274801	09/01/2004	60105278.1
DC4844-KR-PCT	SOUTH KOREA	Thermoplastic Silicone Elastomers Formed From Nylon Resins	DOW SILICONES CORPORATION	03/21/2001	2002/7012809	2002-7012809	04/23/2007	712388
DC4844-US-CIP	United States Of America	Thermoplastic Silicone Elastomers Formed From Nylon Resins	DOW SILICONES CORPORATION	10/26/2001	10/015155	2002-0086937	03/30/2004	6713569
DC4844-US-NP	United States Of America	Thermoplastic Silicone Elastomers Formed From Nylon Resins	DOW SILICONES CORPORATION	03/27/2000	09/535556		03/26/2002	6362287
DC4891-DE-EPT	Germany	Thermoplastic Silicone Elastomers Formed From Polyester Resins	DOW SILICONES CORPORATION	12/03/2001	01999611.5	1354003	09/29/2004	60106086.5
DC4891-US-NP	United States Of America	Thermoplastic Silicone Elastomers Formed From Polyester Resins	DOW SILICONES CORPORATION	12/04/2000	09/728920	2002-0103308	07/09/2002	6417293

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DC4912-US-NP	United States Of America	Polyolefin Thermoplastic Silicone Elastomers Employing Radical Cure	DOW SILICONES CORPORATION	04/30/2001	09/843906		11/12/2002	6479580
DC4913-US-NP	United States Of America	Thermoplastic Silicone Elastomers Employing Radical Cure	DOW SILICONES CORPORATION	05/01/2001	09/845971		10/15/2002	6465552
DC4962-CN-PCT	China	Thermoplastic Silicone Elastomers from Compatibilized Polyester Resins	DOW SILICONES CORPORATION	10/15/2002	02820615.0	1571820	04/19/2006	02820615.0
DC4962-DE-EPT	Germany	Thermoplastic Silicone Elastomers from Compatibilized Polyester Resins	DOW SILICONES CORPORATION	10/15/2002	02802140.0	1444298	10/07/2009	60233958.8
DC4962-US-NP	United States Of America	Thermoplastic Silicone Elastomers from Compatibilized Polyester Resins	DOW SILICONES CORPORATION	10/19/2001	10/043776		05/27/2003	6569958
DC4967-BR-PCT	Brazil	Thermoplastic Polyurethane-Silicone Elastomers	DOW SILICONES CORPORATION	10/22/2002	PI0213015-7		09/04/2012	PI0213015-7
DC4967-CA-PCT	Canada	Thermoplastic Polyurethane-Silicone Elastomers	DOW SILICONES CORPORATION	10/22/2002	2464455		01/04/2011	2464455
DC4967-CN-PCT	China	Thermoplastic Polyurethane-Silicone Elastomers	DOW SILICONES CORPORATION	10/22/2002	02820341.0	1568351	03/22/2006	02820341.0
DC4967-DE-EPT	Germany	Thermoplastic Polyurethane-Silicone Elastomers	DOW SILICONES CORPORATION	10/22/2002	02791189.0	1440122	09/12/2007	60222454.3
DC4967-JP-PCT	Japan	Thermoplastic Polyurethane-Silicone Elastomers	DOW SILICONES CORPORATION	10/22/2002	2003-538266		08/03/2012	5052738
DC4967-KR-PCT	SOUTH KOREA	Thermoplastic Polyurethane-Silicone Elastomers	DOW SILICONES CORPORATION	10/22/2002	10-2004-7005954		06/30/2010	0968355
DC4967-US-NP	United States Of America	Thermoplastic Polyurethane-Silicone Elastomers	DOW SILICONES CORPORATION	10/23/2002	10/278532	20030109623	07/06/2004	6759487
DC5026-US-NP	United States Of America	Polyamide Based Thermoplastic silicone Elastomers	DOW SILICONES CORPORATION	07/18/2002	10/199345	2004-0014888	06/01/2004	6743868
DC5108-CN-PCT	China	Method For Producing Hydrogenated Silicon-Oxycarbide Films	DOW SILICONES CORPORATION	01/26/2004	200480005345.0	1754252	09/03/2008	200480005345.0
DC5108-JP-PCT	Japan	Method For Producing Hydrogenated Silicon-Oxycarbide Films	DOW SILICONES CORPORATION	01/26/2004	2006-503062	2006519496	12/09/2011	4881153
DC5108-KR-PCT	SOUTH KOREA	Method For Producing Hydrogenated Silicon-Oxycarbide Films	DOW SILICONES CORPORATION	01/26/2004	10-2005-7015852		05/31/2011	101039242
DC5108-TW-NP	Taiwan	Method For Producing Hydrogenated Silicon-Oxycarbide Films	DOW SILICONES CORPORATION	01/27/2004	093101750	200420750	07/21/2012	I368670
DC5108-US-PCT	United States Of America	Method For Producing Hydrogenated Silicon-Oxycarbide Films	DOW SILICONES CORPORATION	01/26/2004	10/543672	200600148252	03/13/2007	7189664
DC5183-CN-PCT	China	Method for Adhering Silicone Gels to Plastics	DOW SILICONES CORPORATION	09/30/2004	200480033420.4	1878577	11/03/2010	200480033420.4
DC5183-DE-EPT	Germany	Method for Adhering Silicone Gels to Plastics	DOW SILICONES CORPORATION	09/30/2004	04785363.5	1684814	10/22/2014	6020040460397
DC5183-FR-EPT	France	Method for Adhering Silicone Gels to Plastics	DOW SILICONES CORPORATION	09/30/2004	04785363.5	1684814	10/22/2014	1684814
DC5183-GB-EPT	United Kingdom	Method for Adhering Silicone Gels to Plastics	DOW SILICONES CORPORATION	09/30/2004	04785363.5	1684814	10/22/2014	1684814
DC5183-US-PCT	United States Of America	Method for Adhering Silicone Gels to Plastics	DOW SILICONES CORPORATION	09/30/2004	10/577032	20070042108	01/24/2012	8101042
PN26-CA-PCT	Canada	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	2408683		08/03/2010	2408683
PN26-CN-PCT	China	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	01809317.5	1429256A	10/21/2005	01809317.5
PN26-DE-EPT	Germany	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	01943369.7	1280863	09/13/2006	60123038.8
PN26-ES-EPT	Spain	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	01943369.7	1280863	09/13/2006	1280863
PN26-FR-EPT	France	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	01943369.7	1280863	09/13/2006	1280863
PN26-GB-EPT	United Kingdom	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	01943369.7	1280863	09/13/2006	1280863

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PN26-IT-EPT	Italy	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	01943369.7	1280863	09/13/2006	1280863
PN26-JP-PCT	Japan	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	2001-582447		07/22/2011	4786853
PN26-KR-PCT	SOUTH KOREA	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	10-2002-7015121	793623	01/04/2008	793623
PN26-US-PCT	United States Of America	ANTIFRICTION COATING	DOW SILICONES CORPORATION	05/11/2001	10/275721	20040127625	11/21/2006	7138184
PN28-EP-EPT	European Procedure (Patents)	ANTI CORROSION TOP COAT COMPOSITION	DOW SILICONES CORPORATION	04/23/2002	02766637.9	1397443		
PN28-KR-PCT	SOUTH KOREA	ANTI CORROSION TOP COAT COMPOSITION	DOW SILICONES CORPORATION	04/23/2002	10-2003-7014260	10-955588	04/23/2010	10-955588
PN28-US-PCT	United States Of America	ANTI CORROSION TOP COAT COMPOSITION	DOW SILICONES CORPORATION	04/23/2002	10/475763	20040137238	12/18/2007	7309528
SN138-CN-PCT	China	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	200480019362.X	1816916	11/17/2010	200480019362X
SN138-DE-EPT	Germany	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	04741014.7	1644989	10/19/2011	602004034918.6
SN138-EP-EPT	European Procedure (Patents)	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	04741014.7	1644989	10/19/2011	1644989
SN138-ES-EPT	Spain	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	04741014.7	1644989	10/19/2011	1644989
SN138-FR-EPT	France	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	04741014.7	1644989	10/19/2011	1644989
SN138-GB-EPT	United Kingdom	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	04741014.7	1644989	10/19/2011	1644989
SN138-IT-EPT	Italy	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	04741014.7	1644989	10/19/2011	1644989
SN138-KR-DIV	SOUTH KOREA	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	20127003252		06/17/2014	1410709
SN138-KR-PCT	SOUTH KOREA	Solar Cells and Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	20067000411		06/12/2012	1157407
SN138-US-CNT	United States Of America	Solar Cellsand Encapsulation Thereof	DOW SILICONES CORPORATION	12/30/2011	13/341120	20120186631	09/30/2014	8847064
SN138-US-PCT	United States Of America	Solar Cellsand Encapsulation Thereof	DOW SILICONES CORPORATION	07/02/2004	10/563677	20060207646	09/30/2014	8847063